TOSHIBA TLSE157P

TENTATIVE

TOSHIBA LED LAMP InGaA&P RED LIGHT EMISSION

TLSE157P

PANEL CIRCUIT INDICATOR

- 5 mm DIAMETER (T1-3/4)
- InGaAℓP RED LED
- All Plastic Mold Type.
- Colorless Clear Lens
- Low Drive Current, High Intensity Red Light Emission Recommended Forward Current: IF = 15~20 mA (DC)
- All Plastic Mold Lens, Provides an Excellent ON-OFF Contrast Ratio.
- Fast Response Time, Capable of Pulse Operation.
- High Power Luminous Intensity
- Without stand-offs
- APPLICATIONS: Suitable for Outdoor Message Signboard, Safety equipment, automotive use.

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT	
Forward Current (DC)	$\mathbf{I_F}$	50	mA	
Reverse Voltage	v_{R}	4	V	
Power Dissipation	$P_{\mathbf{D}}$	120	mW	
Operating Temperature Range	${ m T_{opr}}$	-30~85	$^{\circ}\mathrm{C}$	
Storage Temperature Range	$ m T_{stg}$	-40~120	°C	

Unit in mm

Weight: 0.31 g

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ELECTRICAL AND OPTICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Forward Voltage	$V_{\mathbf{F}}$	$I_{ m F}=20~{ m mA}$	_	1.95	2.4	V
Reverse Current	${ m I}_{ m R}$	$V_{R} = 4 V$	_	_	50	μ A
Luminous Intensity	$I_{ m V}$	$I_{ m F}=20{ m mA}$	476	1900	_	mcd
Peak Emission Wavelength	$\lambda_{\mathbf{p}}$	$I_{ m F}=20~{ m mA}$	_	623		nm
Spectral Line Half Width	Δλ	$ m I_F = 20~mA$	_	15	_	nm
Dominant Wavelength	$^{\lambda}\mathbf{d}$	$I_{ m F}=20{ m mA}$	_	613		nm

(Note): Lamps are classified into the following three ranks according to their luminous intensity. Measurement tolerance for each limit is ±15%.

R: 560-1120 mcd, S: 1000-2000 mcd, T: 1800-3600 mcd.

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- garbage.

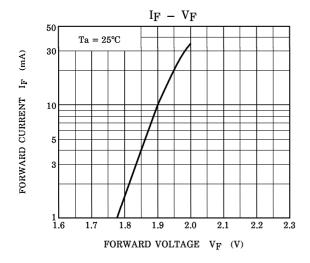
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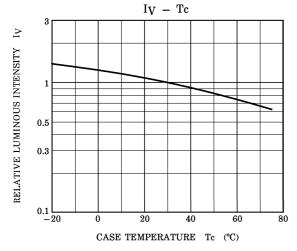
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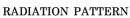
PRECAUTION

Please be careful of the followings

- Soldering temperature: 260°C max Soldering time: 3 s max (Soldering portion of lead: up to 2 mm from the body of the device)
- If the lead is formed, the lead should be formed up to 5 mm from the body of the device without forming stress to the resin. Soldering should be performed after lead forming.
- This visible LED lamp also emits some IR light. If a photodetector is located near the LED lamp, please ensure that it will not be affected by this IR light.







 $Ta = 25^{\circ}C$

